

Compliant with USB standard specification 3.0, backward compatible with USB 2.0 and USB 1.1

 silicon-power.com/web/gb/product-UFD350



Specifications

- Capacity
 - 32GB ~ 128GB
- Interface
 - USB 3.0
- Storage Temperature
 - -55°C ~ 95°C
- Seq. Performance Read (max.)
 - 200 MB/s

- Seq. Performance Write (max.)
- 140 MB/s

- Power Requirement
- DC 5.0V

- Power Consumption(max.)
- 330mA

- Power Consumption (idle)
- 65mA

- Dimension (mm)
- 60.6 x 18.0 x 8.1

- MTBF (est)
- ≧2,000,000 hrs

- Operating Temp. (Standard)
- SP***GIUFD351NVo

- Operating Humidity
- 10% ~ 95% (30°C Max Wet Bulb Temp)

- Vibration
- 15G, 10 ~ 2000Hz

- Drop
- 75cm

- Shock
- 1,500G@0.5ms

- Duration (cycles)
- 10000

- Warranty
- 3 years and within guranteed TBW

Features

- Compliant with USB standard specification 3.0, backward compatible with USB 2.0 and USB 1.1
- Support USB mass Storage Command Protocol
- Operating as Boot Disk, or Code Storage Device for Embeded Operating System

UFD350 3D TLC

Form Factor	NAND	Interface	Capacity	Temp.	P/N
UFD	3D TLC	USB 3.0	32GB	0~70°C	SP032GIUFD355NV0
UFD	3D TLC	USB 3.0	64GB	0~70°C	SP064GIUFD355NV0
UFD	3D TLC	USB 3.0	128GB	0~70°C	SP128GIUFD355NV0